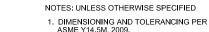


SOT-23/SUPERSOT [™] -23, 3 LEAD, 1.4x2.9 CASE 527AG

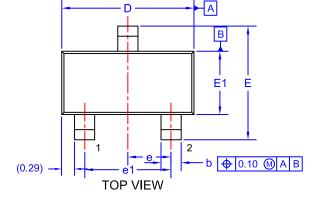
ISSUE A

DATE 09 DEC 2019



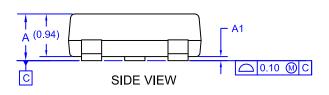
SEE DETAIL A

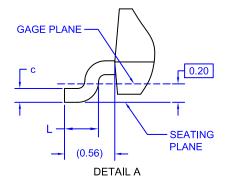
 DIMENSIONING AND TOLERANCING PE ASME Y14.5M, 2009.
ALL DIMENSIONS ARE IN MILLIMETERS 3

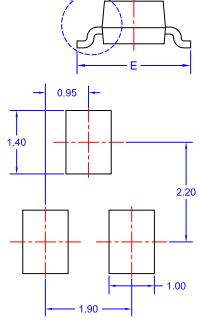


D

5.	ALL DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.						
	DIM	MIN.	NOM.	MAX.			
	А	0.85	0.95	1.12			
	A1	0.00	0.05	0.10			
	b	0.370	0.435	0.508			
	с	0.085	0.150	0.180			
	D	2.80	2.92	3.04			
	Е	2.31	2.51	2.71			
	E1	E1 1.20 1.		1.52			
	е	0.95 BSC 1.90 BSC 0.33 0.38 0.43					
	e1						
	L						







LAND PATTERN RECOMMENDATION* *FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC **MARKING DIAGRAM***

	RAM* XXX = Specific D M = Month Co • = Pb-Free R (Note: Microdot may be in	de Package	*This information is generic. Plea device data sheet for actual par Pb-Free indicator, "G" or microd or may not be present. Some pro not follow the Generic Marking.	rt marking. ot "∎", may
DOCUMENT NUMBER: 98AON34319E		Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOT-23/SUPERSOT-23, 3	/SUPERSOT-23, 3 LEAD, 1.4X2.9		PAGE 1 OF 1

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